



Shanghai, China

## Electronics Equipment

---

- 2x DEK Horizon solder paste machine (03ix)
- 1x DEK Galaxy solder paste machine
- 2xCybersentry paste height inspection system SE 500 & SE 200
- 2x Fuji CP743 and 2xCP6 high speed component placement machines
- 8x Fuji NXT III high speed component placement machines
- 2 x Advantis accurate component placement machines
- 3x Heller Reflow Oven(1912/3)
- 2xStencil cleaner(RL SC PII/PIII)
- 3xWave soldering Oven(JT 350/450,WSN-450)
- 2 x Teradyne Spectrum 8852/51 ICT tester system
- 1 x Selective soldering machine (Vitronics Soltek mySelective 6746)
- 1 x Radial chip placing machine & 1 x Axial chip placing machine(Universal 6360D/6241F)
- 1 x X-Ray YES Tech (YTX-3000) and 1 x BGA Rework Station Metcal (APR500XLS)
- 1 x AOI YES Tech (YTV-FIS) 2D
- 1 x AOI Cybersentry (QX600-L) 2D
- 2 x automation conformal coating machine(Asymtek SL940E)